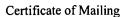
IFW



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Cathy Dixon

on <u>July 15/04</u>
(Pate)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor(s): Kuo-Feng Chen

Serial No.:10/621,252

Filed: July 7, 2003

Title: Method And Apparatus For Pretreating A Substrate Prior To Electroplating

Examiner: Stinson, Frankie L. Group Art Unit: 1746

Attorney Docket No. 67,200-569A

AMENDMENT

Sir:

In response to the office action of April 27, 2004, please amend the above identified application as follows.

There are no amendments to the Specification in this paper.

Amendments to the claims are reflected in the listing of claims that begins on page 2 of this paper.

There are no amendments to the drawings.

Remarks/Arguments begin on page 4 of this paper.